



#10 IDS  
M. Brunson  
8/15/02  
PATENT

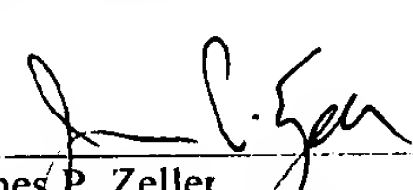
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Jeun et al.  
Ser. No. : 09/677,558  
Filed : September 29, 2000  
For : Semiconductor Power Module  
Having an Electrically Insulating  
Heat Sink and Method of  
Manufacturing the Same  
Art Unit : 2814  
Examiner : DiLinh Nguyen

I hereby certify that this paper is being  
deposited with the United States Postal  
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Washington, D.C. 20231, on this date:

Date: August 5, 2002

  
James P. Zeller  
Registration No. 28,491

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents  
Washington, D.C. 20231

Sir:

Pursuant to the duty of disclosure under 37 C.F.R. §1.56, the documents identified on  
the enclosed form PTO-1449, copies of which are enclosed, are submitted herewith for  
consideration in connection with the present application.

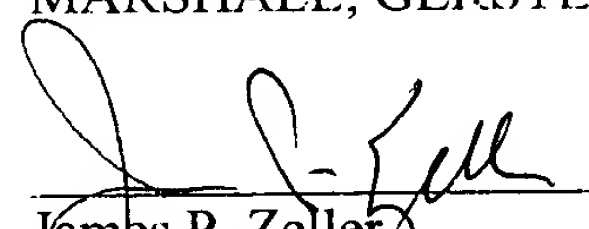
The enclosed documents were first cited by a foreign patent office in a related foreign  
application less than three months from the filing date of this paper. Accordingly, no fee is  
due.

Respectfully submitted,

MARSHALL, GERSTEIN & BORUN

Date: August 5, 2002

By:

  
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